VS-25TTS08FP-M3, VS-25TTS12FP-M3

Vishay Semiconductors

Thyristor High Voltage, Phase Control SCR, 25 A



PRIMARY CHARACTERISTICS				
I _{T(AV)} 16 A				
V_{DRM}/V_{RRM}	800 V, 1200 V			
V_{TM}	1.25 V			
I _{GT}	45 mA			
T_J	-40 °C to 125 °C			
Package	3L TO-220 FullPAK			
Circuit configuration	Single SCR			

FEATURES

- Designed and qualified for industrial level
- Fully isolated package (V_{INS} = 2500 V_{RMS})
- 125 °C max. operating junction temperature
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

 Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding, and battery charge

DESCRIPTION

The VS-25TTS...FP... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS					
APPLICATIONS	SINGLE-PHASE BRIDGE	THREE-PHASE BRIDGE	UNITS		
Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C, common heatsink of 1 °C/W	18	22	А		

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
I _{T(AV)}	Sinusoidal waveform	16	Δ.		
I _{RMS}		25	Α		
V _{RRM} /V _{DRM}		800, 1200	V		
I _{TSM}		350	A		
V _T	16 A, T _J = 25 °C	1.25	V		
dV/dt		500	V/µs		
dl/dt		150	A/µs		
T _J		-40 to +125	°C		

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA			
VS-25TTS08FP-M3	800	800	10			
VS-25TTS12FP-M3	1200	1200				



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ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
PANAMETEN	STIVIDOL	TEST CONDITIONS	TYP. MAX.	
Maximum average on-state current	$I_{T(AV)}$	$T_C = 51$ °C, 180° conduction half sine wave	16	
Maximum RMS on-state current	I _{RMS}		25	Α
Maximum peak, one-cycle,	ı	10 ms sine pulse, rated V _{RRM} applied	300	_ ^
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no voltage reapplied	350	
Maximum 12t fau fuaina	I ² t	10 ms sine pulse, rated V _{RRM} applied	450	A2a
Maximum I ² t for fusing	I-l	10 ms sine pulse, no voltage reapplied	630	A ² s
Maximum I ² √t for fusing	I ² √t	t = 0.1ms to 10 ms, no voltage reapplied	6300	A²√s
Maximum on-state voltage drop	V_{TM}	16 A, T _J = 25 °C	1.25	V
On-state slope resistance	r _t	T _{.I} = 125 °C	12.0	mΩ
Threshold voltage	V _{T(TO)}	1j=125 C	1.0	V
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	$T_J = 25 ^{\circ}\text{C}$ $V_B = \text{Rated } V_{BBM}/V_{DBM}$	0.5	
waxiinuiii reverse and direct leakage current	'RM/ 'DM	T _J = 125 °C	10	
Holding current	Ι _Η	Anode supply = 6 V, resistive load, initial I_T = 1 A, T_J = 25 $^{\circ}$ C	- 150	mA
Maximum latching current	lι	Anode supply = 6 V, resistive load, T _J = 25 °C 200		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80 \text{ %, } V_{DRM} = R_g - k = Open$ 500		V/µs
Maximum rate of rise of turned-on current	dI/dt		150	A/µs

TRIGGERING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak gate power	P _{GM}		8.0	w
Maximum average gate power	P _{G(AV)}		2.0	- vv
Maximum peak positive gate current	+ I _{GM}		1.5	Α
Maximum peak negative gate voltage	- V _{GM}		10	٧
Maximum required DC gate current to trigger	l _{GT}	Anode supply = 6 V, resistive load, T _J = - 10 °C	60	mA
		Anode supply = 6 V, resistive load, T _J = 25 °C	45	
		Anode supply = 6 V, resistive load, T _J = 125 °C	20	
Maximum vaguired DC gata		Anode supply = 6 V, resistive load, T _J = - 10 °C	2.5	
Maximum required DC gate voltage to trigger	V _{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	Ī ,,
		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V
Maximum DC gate voltage not to trigger	V _{GD}		0.25	
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value		mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9	
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	4	μs
Typical turn-off time	t _q	1j = 125 C	110	



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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T_J , T_{Stg}		-40 to 125	°C
Maximum thermal resistance, junction to case		R_{thJC}	DC operation	2.5	
Maximum thermal resistance, junction to ambient		R _{thJA}		62	°C/W
Typical thermal resistance, case to heatsink		R_{thCS}	Mounting surface, smooth, and greased	0.5	
Approximate weight				2	g
Approximate weight				0.07	OZ.
Mounting torque	minimum			6 (5)	kgf · cm
Wounting torque	maximum			12 (10)	(lbf ⋅ in)
Marking device		Occasional TO 2000 Full DAM	25TTS0	8FP	
		Case style 3L TO-220 FullPAK	25TTS1:	2FP	

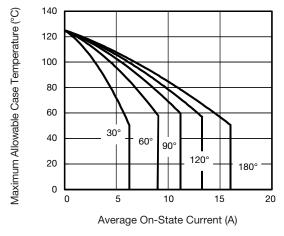


Fig. 1 - Current Rating Characteristics

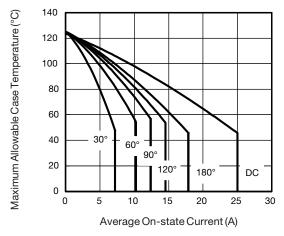


Fig. 2 - Current Rating Characteristics

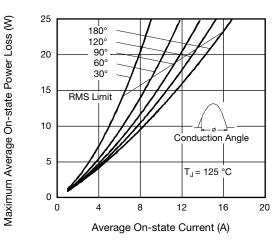


Fig. 3 - On-State Power Loss Characteristics

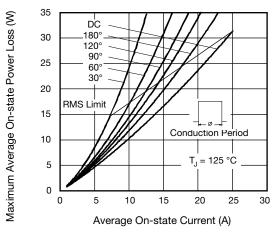


Fig. 4 - On-State Power Loss Characteristics

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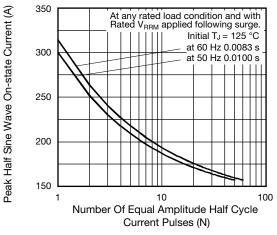


Fig. 5 - Maximum Non-Repetitive Surge Current

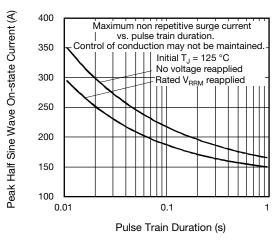


Fig. 6 - Maximum Non-Repetitive Surge Current

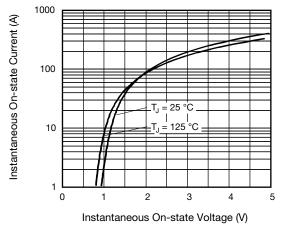


Fig. 7 - On-State Voltage Drop Characteristics

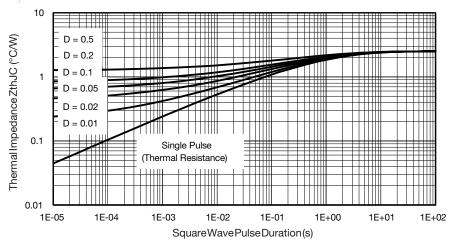


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

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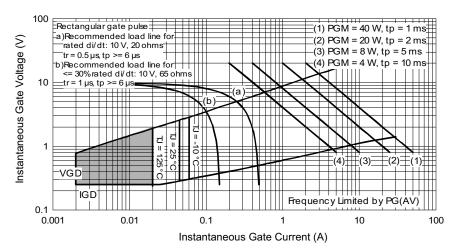
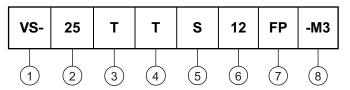


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (25 = 25 A)
- 3 Circuit configuration:

T = single thyristor

4 - Package:

T = TO-220AB

5 - Type of silicon:

Standard recovery rectifier

7 - FullPAK

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-25TTS08FP-M3	50	1000	Antistatic plastic tubes		
VS-25TTS12FP-M3	50	1000	Antistatic plastic tubes		

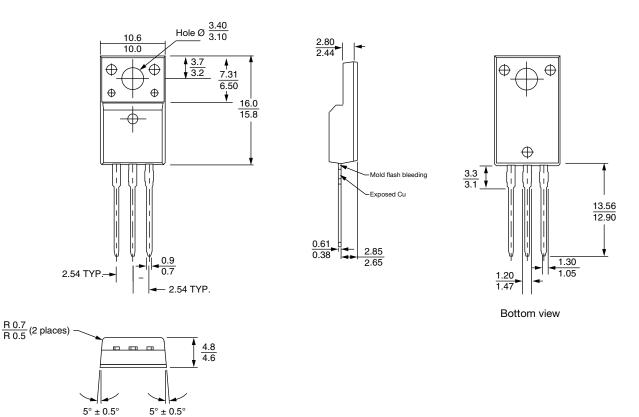
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?96155		
Part marking information	www.vishay.com/doc?95456		



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3L TO-220 FullPAK

DIMENSIONS in millimeters



Notes

- (1) All dimensions are in mm
- (2) Package body size exclude mold flash and burrs. Moldflash should be less than 6 mils



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